

ISL58781

Laser Diode Driver with Serial Control and Write Current DAC

FN6909
Rev 3.00
December 3, 2015

The ISL58781 is a highly integrated laser diode driver designed to support multi-standard writable optical drives in CD, DVD, and Blu-Ray at various speeds. It is a 'hybrid' part having an interface compatible with a conventional LDD, but an internal architecture similar to a write strategy LDD. This combination adds versatility to the conventional interface.

The rise and fall times and overshoot of the blue output are adjustable to compensate for high and low resistance lasers.

There are two banks of write currents with a bank select line, BSEL. This eliminates the need to synchronize the serial port to the media.

The oscillator can be controlled by external LVDS lines, or internally activated through program assignment to any WEN state.

The WEN lines have internal 100Ω terminators. There is a skew detector on the WEN receiver outputs.

The ISL58781 requires a single 5V supply.

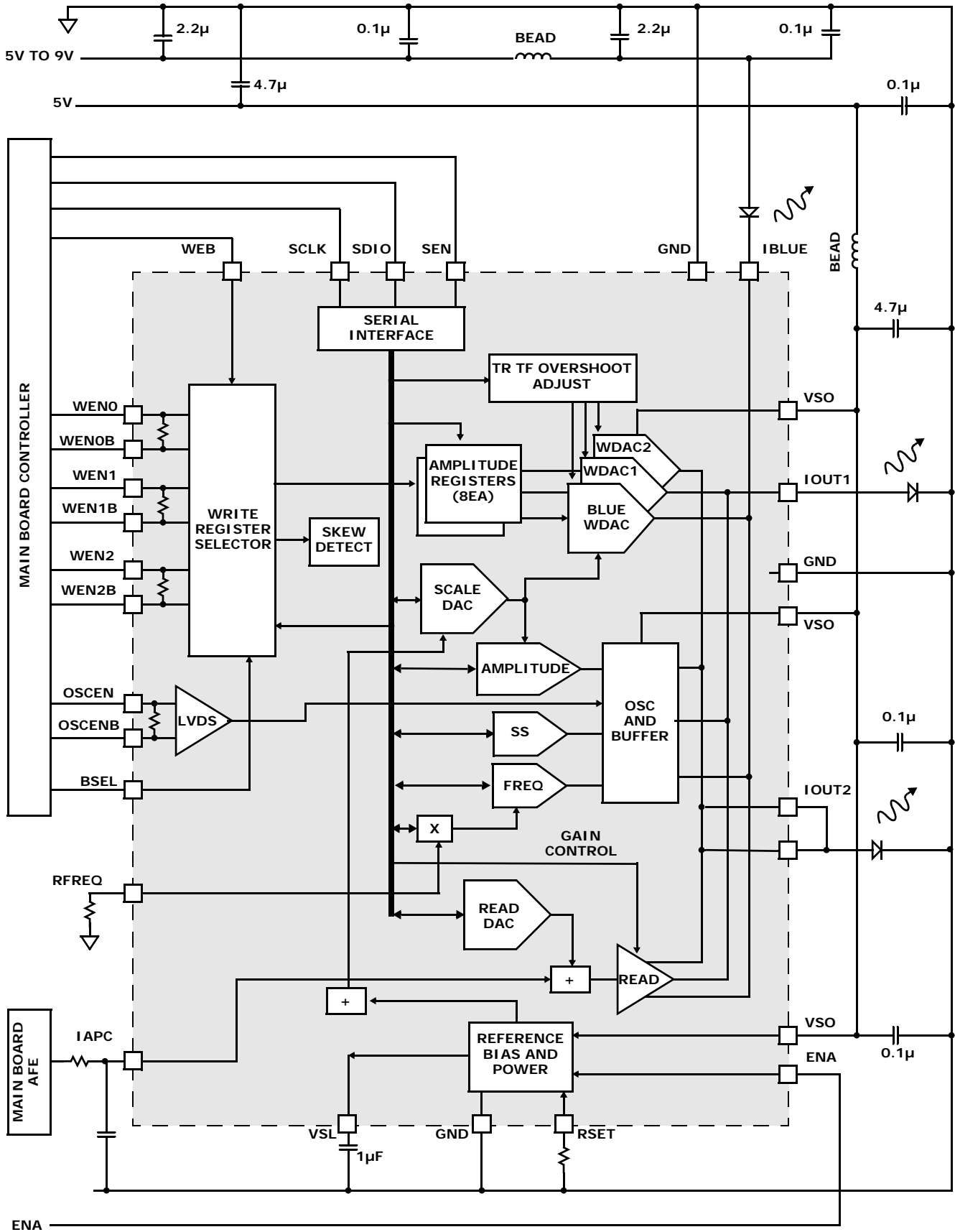
Features

- Compatible with all Conventional Controllers Having a Serial Port, with Some Programming
- Programmable Snubber on all Outputs
- Compatible with Future Controllers Having Gray Coded WEN Lines for Glitchless High-Speed Operation
- WEN Line Skew Detection
- 1000mA Maximum Total Output
- 10-bit x 10-bit Multiplying DAC Output Provides 10-bit Full Scale Adjustment and 10-bit Resolution at any Full Scale Output
- Three Laser Outputs Allow Read/Write DVD, CD, and Blue Combinations
- Analog Inputs Supports Read APC
- HFM Oscillator Programmable to 100mAp-p and Range from 100MHz to >1GHz
- Programmable HFM On, Off and Cooling Levels
- Programmable Spread Spectrum for Low EMI
- Built-in ADC to Sample Laser Voltage Allows Power Reduction by Optimizing Headroom
- Built-in Thermal Sensor Aids in Thermal Design
- Serial Input Works up to 50MHz
- Pb-Free (RoHS Compliant)

Applications

- Combination DVD, CD, and Blue Writable Drives
- BD Camcorders
- BD Video Recorders

Application Block Diagram

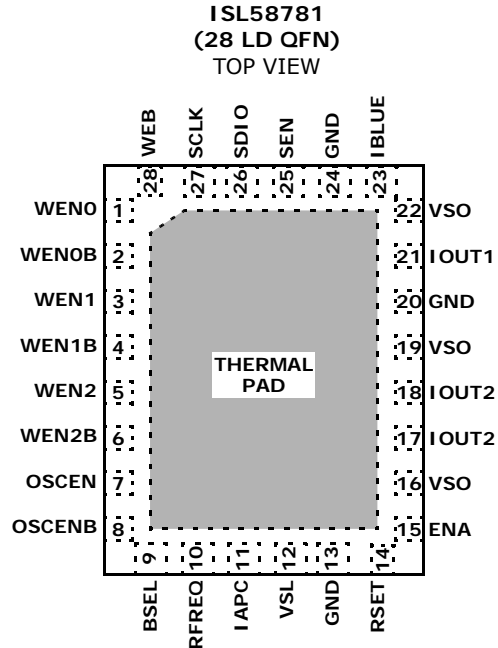


Ordering Information

| PART NUMBER | PART MARKING | TEMP RANGE (°C) | PACKAGE (Pb-free) | PKG. DWG.# |
|------------------------------------|--------------|-----------------|-------------------|------------|
| ISL58781CRZ-T13 (Notes 1, 2, 3) | 58781 CRZ | -10 to +85 | 28 Ld QFN | L28.4x5A |

1. Please refer to TB347 for details on reel specifications.
2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
3. For Moisture Sensitivity Level (MSL), please see device information page for [ISL58781](#). For more information on MSL please see techbrief [TB363](#).

Pin Configuration



Pin Descriptions

| PIN NAME | PIN NUMBER | I/O | PIN TYPE | PIN DESCRIPTION |
|---------------|------------|-----|----------|---|
| WEN0, WEN0B | 1, 2 | I | LVDS | Write Enable 0. When WEN0 > WEN0B, the result is a logic 1 in the write current selection. Otherwise it is logic 0. |
| WEN1, WEN1B | 3, 4 | I | LVDS | Write Enable 1. When WEN1 > WEN1B, the result is a logic 1 in the write current selection. Otherwise it is logic 0. |
| WEN2, WEN2B | 5, 6 | I | LVDS | Write Enable 2. When WEN2 > WEN2B, the result is a logic 1 in the write current selection. Otherwise it is logic 0. |
| OSCEN, OSCENB | 7, 8 | I | LVDS | Oscillator Enable. When OSCEN > OSCENB, the result is a logic 1, which may be used to turn on the oscillator. When 0, the oscillator will output a DC current that is programmable. |
| BSEL | 9 | I | Digital | Bank Select input selects the write current register banks. |
| RFREQ | 10 | I/O | Analog | A resistor from RFREQ to GND sets the range of the HFM frequency. |
| IAPC | 11 | I | Analog | A 1kΩ impedance current input; 100*IAPC flow to the output. This controls the read current, which may also include a current from an internal DAC. |
| VSL | 12 | O | Power | The internal 2.5V regulator needs a 1μF capacitor from VSL to GND. Do not use VSL for other loads. |
| GND | 13, 20 | | Ground | Ground |
| RSET | 14 | I/O | Analog | A resistor from RSET to analog ground calibrates the DAC full-scales |
| ENA | 15 | I | Digital | Chip enable input (H = enable, L = disable) |
| VSO | 16, 19, 22 | | Power | Supply voltage for the output drivers only (connect all pins) |
| IOUT2 | 17, 18 | O | Analog | Laser diode output #2 |
| IOUT1 | 21 | O | Analog | Laser diode output #1 |
| IBLUE | 23 | O | Analog | Blue laser diode output |
| SEN | 25 | I | Digital | Serial control enable (H = enable, L = disable) |
| SDIO | 26 | I/O | Digital | Serial data for parameters and control; in/out |
| SCLK | 27 | I | Digital | Serial control clock |
| WEB | 28 | I | Digital | Write enable Bar. When low, write current is enabled. |
| PD | | | Thermal | The Thermal pad should be grounded and connected to a heat sink. |

NOTE: Pins with the same name are internally connected together; however, LDD pins must not be used for connecting together external components or features.

Absolute Maximum Ratings ($T_A = +25^\circ\text{C}$)

| | |
|--|--------------------------|
| V_{SO} , Supply Voltages | 6V |
| I_{BLUE} , Voltage at I_{BLUE} | 7V |
| $I_{OUT1,2}$, Output Current | 1000mApk |
| I_{BLUE} , Output Current | 600mApk |
| V_{IN} , Logic Input Voltages | -0.5V to $V_{SO} + 0.5V$ |
| I_{IN} , Current into R_{SET} , R_{FREQ} , I_{APC} | 5mA |
| ESD Rating | |
| Human Body Model | 2500V |

Thermal Information

| | | |
|-----------------------------------|---|---|
| Thermal Resistance (Typical) | θ_{JA} ($^\circ\text{C}/\text{W}$) | θ_{JC} ($^\circ\text{C}/\text{W}$) |
| 28 Lead QFN (Notes 4, 5) | 37 | 2.9 |
| P_D , Maximum Power Dissipation | see curves on page 12 | |
| T_S , Storage Temperature Range | -60 $^\circ\text{C}$ to +150 $^\circ\text{C}$ | |
| Pb-Free Reflow Profile | see link below | |
| | http://www.intersil.com/pbfree/Pb-FreeReflow.asp | |

Operating Conditions

| | |
|------------------------------------|---|
| T_A , Ambient Temperature Range | -10 $^\circ\text{C}$ to +85 $^\circ\text{C}$ |
| T_J , Junction Temperature Range | -10 $^\circ\text{C}$ to +150 $^\circ\text{C}$ |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
- For θ_{JC} , the "case temp" location is the center of the exposed metal pad on the package underside.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$

Electrical Specifications Unless otherwise indicated, all of the following tables are: $V_{SO} = V_{HI} = 5V$, $R_{SET} = 620\Omega$, $R_{FREQ} = 4.7k\Omega$, $R_{LOAD-IOUT1/2} = 8\Omega$ to GND, $R_{LOAD-BLUE} = 10\Omega$ to V_{HI} , $P_{MAX} = 0x3FF$, Reg 1 21 = 88h, Reg x-00 bit6 = 0b, $T_A = +25^\circ\text{C}$.

| PARAMETER | DESCRIPTION | MIN | TYP | MAX | UNIT |
|-------------------------------------|--|-----|-----|-----|---------------|
| DC ELECTRICAL SPECIFICATIONS | | | | | |
| V_{SO} | (Notes 6, 7) | 4.5 | | 5.7 | V |
| V_{IBLUE} | I_{IBLUE} pin; $R_{LOAD} = 10\Omega$ | | | 7.0 | V |
| I_{VSO} | Supply Current (No Current Output) | | 25 | 35 | mA |
| $I_S, dis_{(nom)}$ | Supply Current, Disable Mode | | 3.5 | 6 | mA |
| $I_S, dis_{(high)}$ | Supply Current; $V_{SO} = 5.5V$, Disable Mode | | 3.9 | 7 | mA |
| $V_{SO, good}$ | V_{SO} Voltage above which STATUS: VDDOK = 1 | 2.9 | | 3.5 | V |
| $I_{BLUE-LEAK(SEL)}$ | $V_{IBLUE} = 7.0V$; I_{IBLUE} is selected | | 150 | 400 | μA |
| $I_{BLUE-LEAK(DE-SEL)}$ | $V_{IBLUE} = 7.0V$; I_{IBLUE} is not selected | | 1.1 | 1.6 | mA |
| V_{IH} | Input Logic High Level | 2.0 | | | V |
| V_{IL} | Input Logic Low Level | | | 0.8 | V |
| V_{OH} | SDIO High Level, $I_L = -5mA$ | 2.4 | | | V |
| V_{OL} | SDIO Low Level, $I_L = 5mA$ | | | 0.4 | V |
| I_{INH} | Logic Input Current High Level | -15 | | +10 | μA |
| I_{INL} | Logic Input Current Low Level | -15 | | +10 | μA |

NOTES:

- Required voltage at the device pins. Allowance must be made for any voltage drop between the power supply and the device.
- Required voltage also depends on laser diode manufacturer and pickup optical efficiency. Also, see R_{OUT} spec of WDAC.

PMAX DAC (10-bit) DC Specifications Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|-----------|----------------------------|-----------------------------------|------|------|------|------|
| DNL-PMAX | Differential Non-Linearity | (Note 8) | -3.5 | | +3.5 | LSB |
| INL-PMAX | Integral Non-Linearity | At 200h Resistive Load ~0V to ~3V | | +40 | | LSB |
| ZS-PMAX | Zero-Scale Error | (Note 9) | -2 | 0 | +2 | LSB |
| VRSET | RSET Pin Voltage | | 1.03 | 1.06 | 1.11 | V |

NOTES:

8. Differential non-linearity (DNL) is the differential between the measured and ideal 1 LSB change of any two adjacent codes.
9. Zero-scale error (ZS) is the deviation from zero current output when the digital input code is zero.

IOUT1/2 Write Power DAC (10-bit) DC Specifications Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN (Note 14) | TYP | MAX (Note 14) | UNIT |
|------------------------|--|---|------------------|-----|------------------|--------|
| DNL-W | Differential Non-Linearity | | -1.7 | | +1.0 | LSB |
| INL-W | Integral Non-Linearity | At 200h Resistive Load ~0V to ~3V | | +21 | | LSB |
| FS _{OUT-W620} | Write DAC Full-Scale Output Current R _{SET} = 620Ω | WriteDAC = 0x3FF. Headroom depends on I _{OUT} . Reg 1-21 = 8F | 475 | 500 | | mA |
| FS _{OUT-H1.1} | Write DAC Full-Scale Output Current | WriteDAC = 0x3FF, Reg 1-21 = 8F Fixed Headroom = 1.1V | 700 | 773 | 875 | mA |
| PSRR _{-FS} | Power Supply Rejection -Full-Scale Current | vs V _{SO} (Note 10) | | -30 | | dB |
| TC _{-FS-IOUT} | Temperature Coefficient -Full-Scale Current | (Note 11) 0°C to +85°C | | -32 | | ppm/°C |
| ZS-W | Zero-scale error | (Note 12) | -2 | 0 | +2 | LSB |
| R _{OUT-WDAC} | Write DAC Output Series Resistance | WriteDAC = P _{MAX} = 0x3FF P _{MAX} bias overdriven (Note 13) | | 1.1 | 1.4 | Ω |

NOTES:

10. Full scale output current power supply sensitivity (SFS) is measured by varying the V_{SO} from 4.5V to 5.5V DC and measuring the effect of this signal on the full-scale output current.
11. Full scale output current temperature coefficient (TFS) is given by delta (full scale output current)/Δ(T).
12. Zero-scale error (ZS) is the deviation from zero current output when the digital input code is zero.
13. P_{MAX} bias overdriven via R_{SET}.
14. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

IBLUE Write Power DAC (10-bit) DC Specifications Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------|--|---|------|-----|------|--------|
| DNL-W | Differential Non-Linearity | | -4.9 | | +2.0 | LSB |
| INL-W | Integral Non-Linearity | At fixed 2.5V headroom | | +60 | | LSB |
| FS _{OUT-H2.0} | Write DAC Full-Scale Output Current R _{SET} = 620Ω | WriteDAC = 0x3FF; Fixed Headroom = 2.0V; Reg 1-21 = 8F | 380 | 445 | 575 | mA |
| TR _{RANGE} | Tr Tf adjustment Range | Reg 1-0A from X0h to X7h | | 1 | | ns |
| PSRR _{FS} | Power Supply Rejection -Full -Scale Current | vs V _{SO} (Note 15) | | -40 | | dB |
| TC _{FS-IBLUE} | Temperature Coefficient -Full-Scale Current | (Note 16) | | 600 | | ppm/°C |
| ZS-W | Zero-Scale Error | V _{IOUT} = 2V (Note 17) | -8 | 0 | +8 | LSB |
| R _{OUT-WDAC} | Write DAC Output Series Resistance | WriteDAC = P _{MAX} = 0x3FF P _{MAX} bias overdriven (Note 18) | | 2.9 | 4.5 | Ω |

NOTES:

15. Full scale output current power supply sensitivity (SFS) is measured by varying the V_{SO} from 4.5V to 5.5V DC and measuring the effect of this signal on the full-scale output current.
16. Full scale output current temperature coefficient (TFS) is given by delta (full scale output current)/Δ(T).
17. Zero-scale error (ZS) is the deviation from zero current output when the digital input code is zero.
18. P_{MAX} bias overdriven via R_{SET}.

IBLUE Read APC Amplifier DC Specifications Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------|--|---|-----|-----|------|-------|
| IAPC _{MIN-GAIN} | Current Gain @Min Gain | Reg1-21h = 1X, I _{APC} = 0μA, 500μA | 8 | 12 | 22 | mA/mA |
| IAPC _{MAX-GAIN} | Current Gain @ Max Gain | Reg1-21h = FX, I _{APC} = 0μA, 500μA | 180 | 220 | 280 | mA/mA |
| IAPC _{GAIN} | Current Gain | I _{APC} = 0μA, 500μA | 80 | 101 | 150 | mA/mA |
| IAPC _{OS} | Current Offset | I _{APC} = 0μA | -2 | 1 | 3 | mA |
| LIN _{APC} | Output Current Linearity | I _{APC} = 0μA, 500μA, 1.0mA | 0 | | 6 | % |
| I _{OUT-R-APC} | Blue Read Output Current, Using I _{APC} Input | I _{APC} = 1.5mA | 150 | | | mA |
| R _{IN} | I _{APC} Input Impedance to GND | | 800 | | 1300 | Ω |
| PSRR _{APC} | I _{APC} Current Power Supply Rejection | I _{OUT-average} = 100mA, varying V _{SO} | | -46 | | dB |

OUT1/2 Read APC Amplifier DC Specifications Standard condition unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------|---|---|------|-----|------|-------|
| IAPC _{MIN-GAIN} | Current Gain @ Min Gain | Reg1-21h = 1X, I _{APC} = 0μA, 500μA | 10.5 | 14 | 17.5 | mA/mA |
| IAPC _{MAX-GAIN} | Current Gain @ Max Gain | Reg1-21h = FX, I _{APC} = 0μA, 500μA | 145 | 163 | 185 | mA/mA |
| IAPC _{GAIN} | Current Gain | I _{APC} = 0μA, 500μA | 82 | 92 | 108 | mA/mA |
| IAPC _{OS} | Current Offset | I _{APC} = 0μA | -2 | 1 | 3 | mA |
| LIN _{APC} | Output Current Linearity | I _{APC} = 0μA, 500μA, 1.0mA | 0 | | 6 | % |
| I _{OUT-R-APC} | Read Output Current, Using I _{APC} Input | I _{APC} = 1.5mA | 120 | | | mA |
| R _{IN} | I _{APC} Input Impedance to GND | | 800 | | 1300 | Ω |
| PSRR _{APC} | I _{APC} Current Power Supply Rejection | I _{APC-IN} = 0.45mA, varying V _{SO} | | -48 | | dB |

Read DAC (12-bit) DC Specifications

Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN (Note 22) | TYP | MAX (Note 22) | UNIT |
|-------------------------------------|---|--|------------------|-----|------------------|--------|
| DNL-R | Read DAC Differential Non-Linearity | PREAD: Reg 0-19 + Reg 1-09 | -2 | | +2 | LSB |
| INL-R | Read DAC Integral Non-Linearity | @ 900h on Resistive Load. 0V to ~3V | | +90 | | LSB |
| I _{OUT} -R-DAC-RED | Read Output Current, Read DAC at Full-Scale, I _{OUT1} or I _{OUT2} | PREAD = 0xFFF, I _{APC} = 0, Reg 1-21 = 8F | 110 | 130 | 170 | mA |
| PSRR- _{FS} | Power Supply Rejection - Full-Scale Current | varying the V _{SO} (Note 14) | | -42 | | dB |
| TC- _{FS} -I _{OUT} | Temperature Coefficient - Full-Scale Current | Not including the R _{SET} tempco (Note 20) 0°C to +85°C | | -48 | | ppm/°C |
| ZS-R | Zero-Scale Error | V _{IOUT} = 2V (Note 16) | -80 | 0 | 80 | LSB |

NOTES:

19. Full scale output current power supply sensitivity (SFS) is measured by varying the V_{SO} from 4.5V to 5.5V DC and measuring the effect of this signal on the full-scale output current.
20. Full scale output current temperature coefficient (TFS) is given by delta (full scale output current)/Δ(T).
21. Zero-scale error (ZS) is the deviation from zero current output when the digital input code is zero.
22. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

HFM (High Frequency Modulator)

Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|------------------------------------|-----|---------|------|-------------------|
| I _{MAX} -RED-OFF-LINK | Max HFM Off DC Output, I _{OUT1} or I _{OUT2} in Link Mode | HFMOFF = 0xFFF | 90 | 120 | 160 | mA |
| I _{MAX} -RED-OFF-UNLINK | Max HFM Off DC Output, I _{OUT1} or I _{OUT2} in Unlink mode | HFMOFF = 0xFFF | 80 | 115 | 150 | mA |
| I _{MAX} -BLUE-OFF | Max HFM Off DC Output, I _{BLUE} | HFMOFF = 0xFFF | 50 | 62 | 80 | mA |
| I _{MIN} -RED-OFF | Min HFM Off DC Output, I _{OUT1} or I _{OUT2} | HFMOFF = 0x000 | -3 | 0 | 3 | mA |
| I _{MIN} -BLUE-OFF | Min HFM Off DC Output, I _{BLUE} | HFMOFF = 0x000 | -3 | 0 | 3 | mA |
| I _{MAX} -RED-ON-LINK | Max HFM Oscillator Output, I _{OUT1} or I _{OUT2} in Link Mode | HFMON = Reg 0-17h = 0xFF | | 118 | | mA _{p-p} |
| I _{MAX} -RED-ON-UNLINK | Max HFM Oscillator Output, I _{OUT1} or I _{OUT2} in Unlink Mode | HFMON = Reg 0-17h = 0xFF | | 114 | | mA _{p-p} |
| I _{MAX} -BLUE-ON | Max HFM Oscillator Output, I _{BLUE} | HFMON = 0xFF | | 60 | | mA _{p-p} |
| F _{OSC} -HI-MAX | Max HFM Frequency, High Range | Reg 0-16 = FFh, Reg X-00 bit 6 = 0 | 900 | 1020 | 1250 | MHz |
| F _{OSC} -HI-MIN | Min HFM Frequency, High Range | Reg 0-16 = 01h, Reg X-00 bit 6 = 0 | 120 | 175 | 240 | MHz |
| F _{OSC} -LO-MAX | Max HFM Frequency, Low Range | Reg 0-16 = FFh, Reg X-00 bit 6 = 1 | 425 | 525 | 625 | MHz |
| F _{OSC} -LO-MIN | Min HFM Frequency, Low Range | Reg 0-16 = 01h, Reg X-00 bit 6 = 1 | 55 | 78 | 105 | MHz |
| PSRR _{OSC} -FREQ | PSRR -HFM Frequency | V _{SO} from 4.5V to 5.0V | | 0.5 | | %/V |
| PSRR _{OSC} -AMP-I _{OUT} | PSRR - HFM Amplitude | 350MHz; HFMON = FFh; Link | | 3 | | %/V |
| PSRR _{OSC} -AMP-I _{BLUE} | PSRR - HFM Amplitude | 700MHz; HFMON = FFh; Link | | 1.2 | | %/V |
| TF _{OSC} 400MAX | HFM Frequency Temperature Coefficient | Range from 200MHz to 400MHz | | 0 - 900 | | ppm/°C |
| TF _{OSC} 900MAX | HFM Frequency Temperature Coefficient | Range from 400MHz to 900MHz | | ±250 | | ppm/°C |
| VR _{FREQ} | R _{FREQ} Pin Voltage | R _{FREQ} = 4.7kΩ | 0.9 | 1.11 | 1.2 | V |

HFM (High Frequency Modulator) Standard conditions unless otherwise noted. (Continued)

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------|--|--|-----|-------|-----|------|
| SS-WIDTH-RANGE | Spread Spectrum Spreading Width Adjustment Range | R _{FREQ} = 4.7kΩ, Reg 1-18 = 10h, Reg 0-16 = 26h; Reg X-00 bit 6 = 0 | 0.1 | 0.525 | 1.1 | % |
| SS_Shift | Shift of Center Frequency when SS is Enabled vs when it's Disabled | R _{FREQ} = 4.7kΩ, Reg 1-18-00h to 30h, Reg 0-16 = 26h; Reg X-00 bit 6 = 0 | | 0.7 | | % |
| SS_Mod | Spread Spectrum Modulation Frequency | REG 1-18h Bit 7 = 0; Reg X-00 bit 6 = 0 | 30 | 53 | 80 | kHz |
| SS_Mod | Spread Spectrum Modulation Frequency | REG 1-18h Bit 7 = 1; Reg X-00 bit 6 = 0 | 15 | 34 | 55 | kHz |

Serial Interface AC Performance Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|---|---|-----|-----|-----|------|
| F _{SER} | SCLK Operating Range | Static logic not limited at low frequency | | | 50 | MHz |
| t _{EH} | SEN "H" Time | @ 50MHz | 320 | | | ns |
| t _{EL} | SEN "L" Time | @ 50MHz | 160 | | | ns |
| t _{ERSR} | SEN Rising Edge to the First SCLK Rising Edge | @ 50MHz | 10 | | | ns |
| t _{CDS} | SDIO Set Up Time | @ 50MHz | | 10 | | ns |
| t _{CDH} | SDIO Hold Time | @ 50MHz | | 10 | | ns |
| t _{SREF} | Last SCLK Rising Edge to SEN Falling Edge | @ 50MHz | 10 | | | ns |
| t _{CC} | SCLK Cycle Time ¹ | @ 50MHz | 20 | | | ns |
| Duty | SCLK "H" Duty Cycle | @ 50MHz | 40 | 50 | 60 | % |
| t _{CDD} | SDIO Output Delay | @ 50MHz | | | 4 | ns |
| t _{EDH} | SDIO Output Hold Time | @ 50MHz | 2 | | | ns |

LVDS Specifications Standard conditions unless otherwise noted.

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------------|------------------------------|--|-----|-----|-----|------------------|
| V _{IN-HIGH} | Maximum Single Line Voltage | | | 2.4 | | V |
| V _{IN-LOW} | Minimum Single Line Voltage | | | 0 | | V |
| C _{IN} | Input Capacitance | | | 2 | | pF |
| R _{IN} | Input Resistance | | 85 | 100 | 115 | Ω |
| V _{MIN} | Minimum Differential Voltage | Signal tested with ±240mV differential input | 240 | | | mV _{PK} |

Laser Driver AC PerformanceDemoboard test, 10% duty cycle pulse, load = equivalent circuitry to [laser + flex cable] and/or as noted. $V_{SO} = 5V$. $T_A = +25^\circ C$

| PARAMETER | DESCRIPTION | CONDITIONS | MIN | TYP | MAX | UNIT |
|-------------------|--|---|-----|------|-----|-----------------|
| $t_{R-IOUTx}$ | $I_{OUT1/2}$ Write Rise Time (10% to 90%) | 300mW Optical ML229U7 (Note 23) | | 1.3 | | ns |
| $t_{F-IOUTx}$ | $I_{OUT1/2}$ Write Fall Time (10% to 90%) | 300mW Optical ML229U7 (Note 23) | | 800 | | ps |
| O/S-IOUTx | $I_{OUT1/2}$ Write Pulse Overshoot | 300mW Optical ML229U7 (Note 23) | | 11 | | % |
| $t_{D-IOUTx}$ | $I_{OUT1/2}$ Write Pulse Delay From LVDS = Zero crossing to I_{OUT} rise 10% | (Note 23) | | 5.3 | | ns |
| t_{R-BLUE} | I_{BLUE} Write Rise Time (10% to 90%) | 250mW Optical (Note 23) | | 600 | | ps |
| t_{F-BLUE} | I_{BLUE} Write Fall Time (10% to 90%) | 250mW Optical (Note 23) | | 450 | | ps |
| O/S-BLUE | I_{BLUE} Write Pulse Overshoot | 250mW Rising Optical (Note 23) | | 6 | | % |
| t_{D-BLUE} | I_{BLUE} Write Pulse Delay From LVDS = Zero crossing to I_{OUT} rise 10% | (Note 23) | | 5.2 | | ns |
| $I_{NOISE-IOUTx}$ | $I_{OUT1/2}$ Read Output Current Noise | $I_{OUT} = 50mA$, measured @ 10MHz | | 0.55 | | nA/ \sqrt{Hz} |
| $I_{NOISE-IOUTx}$ | $I_{OUT1/2}$ Read & HFM Output Current Noise | $I_{OUT} = 50mA+30mA_{p-p}$; Measured @ 10MHz | | 0.96 | | nA/ \sqrt{Hz} |
| $I_{NOISE-BLUE}$ | I_{BLUE} Read Output Current Noise | $I_{OUT} = 50mA$, measured @ 10MHz | | 0.37 | | nA/ \sqrt{Hz} |
| $I_{NOISE-BLUE}$ | I_{BLUE} Read & HFM Output Current Noise | $I_{OUT} = 50mA+10mA_{p-p}$; Measured @ 10MHz | | 0.47 | | nA/ \sqrt{Hz} |
| BW_{APC} | Read Amplifier 3dB Bandwidth | $I_{OUT} = 50mA$ | | 0.5 | | MHz |

NOTE:

23. Limits established by characterization and are not production tested

TABLE 1. AMPLITUDE SELECTION REGISTER ACTIVATION

| NAME | ENA | WEB | CRO Bit 2 | WEN2 | WEN1 | WENO | MSB BSEL = 0 | LSB BSEL = 0 | MSB BSEL = 1 | LSB BSEL = 1 |
|------|-----|-----|-----------|------|------|------|--------------|--------------|--------------|--------------|
| OFF | 0 | X | x | X | X | X | X | X | X | X |
| READ | 1 | 1 | 0 | X | X | X | 0-19 | 1-09 | 0-19 | 1-09 |
| W0 | 1 | 0 | 1 | 0 | 0 | 0 | 0-10 | 2-10 | 0-11 | 2-11 |
| W1 | 1 | 0 | 1 | 0 | 0 | 1 | 0-04 | 2-04 | 0-05 | 2-05 |
| W2 | 1 | 0 | 1 | 0 | 1 | 0 | 0-06 | 2-06 | 0-07 | 2-07 |
| W3 | 1 | 0 | 1 | 0 | 1 | 1 | 0-08 | 2-08 | 0-09 | 2-09 |
| W4 | 1 | 0 | 1 | 1 | 0 | 0 | 0-0A | 2-0A | 0-0B | 2-0B |
| W5 | 1 | 0 | 1 | 1 | 0 | 1 | 0-0C | 2-0C | 0-0D | 2-0D |
| W6 | 1 | 0 | 1 | 1 | 1 | 0 | 0-0E | 2-0E | 0-0F | 2-0F |
| W7 | 1 | 0 | 1 | 1 | 1 | 1 | 0-12 | 2-12 | 0-13 | 2-13 |

NOTES:

24. There are two sets of write current registers. When BSEL = 1, bank 1 is selected. When BSEL = 0, bank 0 is selected.

25. Read and write are independent. Read is enabled with a control bit.

26. Register terminology is page Number-Register number (hex). Thus 1-09 is page 1, register 09h

Applications Information

I_{OUT}

The data sheet values for oscillator current, and write current are based on an R_{SET} of 620Ω when P_{MAX} and WriteDAC are both set to full scale. The user may choose R_{SET} to match the output current needs of the application.

The P_{MAX} DAC is biased by I_{RSET} (= V_{RSET}/R_{SET}). See the "Typical Performance Curves" on page 10.

The write channel output capability for a typical part is shown in Figure 1. The amount of I_{OUT} will be limited by the available headroom voltage at the I_{OUTX} pins.

A four input DAC (Reg 1-0A bits 3, 2, 1, 0) can be used to control the amount of RC snubbing applied to the outputs.

Read current may be controlled by either the Read DAC or the I_{APC} input. When set by P_{READ}, I_{READ} is limited to the data sheet value, whereas the I_{APC} input will allow a significantly higher value to be obtained. The ReadDAC and I_{APC} currents sum together.

Glitches could occur if two or three WEN lines are changed simultaneously, and the propagation delay is different for the two lines between the inner circuits of the controller and the inner circuits of the LDD. Because the WEN lines are encoded, the selected write current will be correct before the change in code, and again after the code changes. But some other output could result momentarily if the propagation delays are not matched. The skew detector detects the first rising edge at the LVDS outputs.

F_{OSC}

Both F_{OSC} and R_{FREQ} may be chosen to accommodate the desired range or operating point of the HFMFREQ

DAC. Although F_{OSC} is relatively linear with DAC code, monotonicity is not guaranteed (see Figure 5). Under extreme conditions, where V_{SO} = 4.5V and temperature is +125°C, the HFM frequency is only capable of 900MHz (see Figure 6).

The oscillator may be turned on either by the OSCEN lines or by the WEN code selected. The particular code that selects the oscillator is under program control. The P_{COOL} function is only available through the program control and WEN selection.

The WEB enables write current. Thus WEN code 000 may also select a write current.

Power

The main power consumption is caused by the headroom voltage across the output stage (V_{SO} - V_{IOUT}) x I_{OUT}. For I_{OUT1} and I_{OUT2}, the V_{SO} can be reduced below 5.0V (but above V_{SO-GOOD}), as long as sufficient headroom voltage is available to obtain the desired output current. For the blue outputs, the built in ADC can be used to obtain the output voltage, which is also the headroom voltage. The HFM oscillator power consumption will increase with increasing frequency and amplitude (see Figure 7).

Note that in the QFN package, the die is mounted directly on the thermal pad. This provides a very low thermal resistance Junction to thermal pad of just a few °C/W. The problem is in moving the heat from the thermal pad to some other heat sink.

Figure 10 shows that when mounted well on a 4-layer PCB with 3 ground plane layers, and an area of 10cmx10cm, the θ_{JA} is +37°C/W. The typical application will not afford this good of a heat sink.

Typical Performance Curves

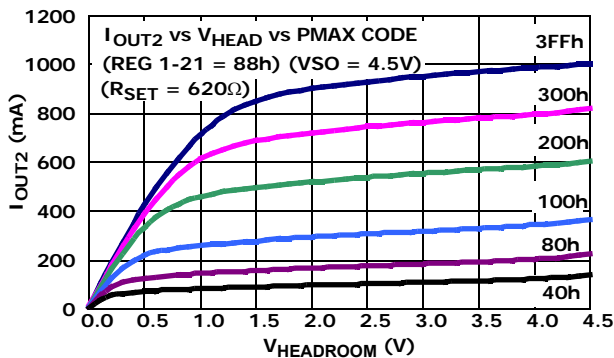


FIGURE 1. I_{OUT} WRITE CURRENT vs V_{SD} vs I_{P_{MAX}_BIAS}

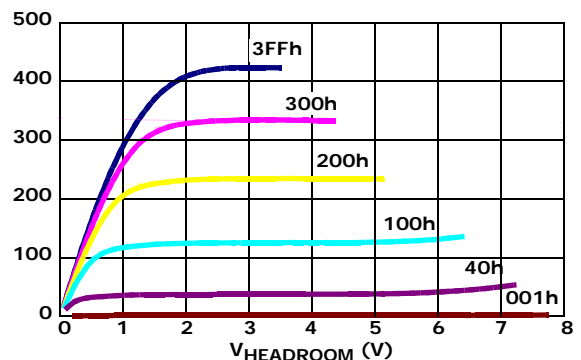


FIGURE 2. I_{BLUE} vs P_{MAX} vs V_{HEADROOM} (V_{SO} = 5.0V) (R_{SET} = 620Ω) (1-21 = FFh), (R_{LOAD} = 10Ω)

Typical Performance Curves (Continued)

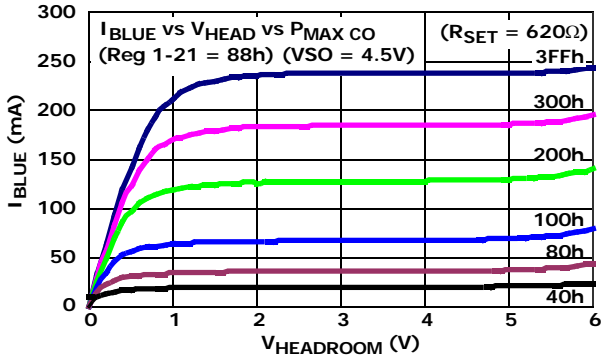


FIGURE 3. I_{BLUE} WRITE CURRENT vs V_{DS} vs $I_{P_{MAX_BIAS}}$

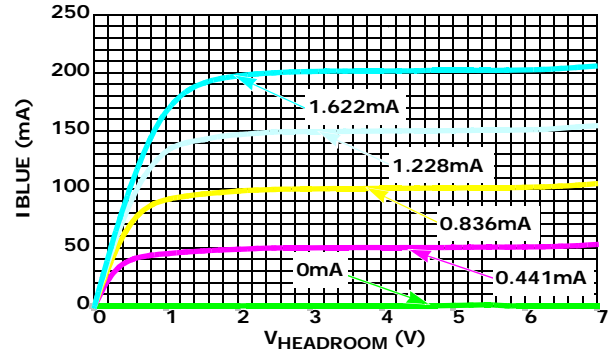


FIGURE 4. I_{BLUE} READ vs $V_{HEADROOM}$ vs I_{APC} , (REG 1-212 = 88h) ($V_{SO} = 5.0V$) ($R_{SET} = 620\Omega$)

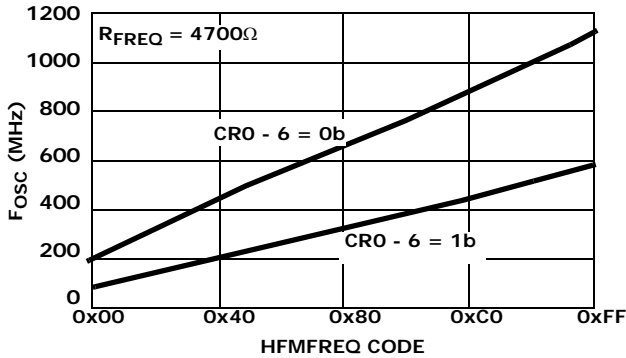


FIGURE 5. HFM CONTROL

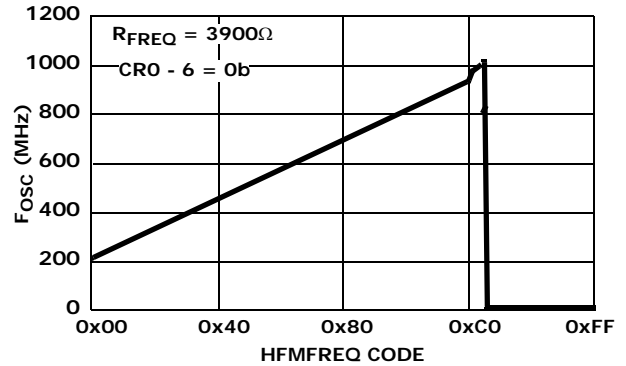


FIGURE 6. HFM CONTROL; $V_{SO} = 4.5V$; $TEMP = +125^{\circ}C$

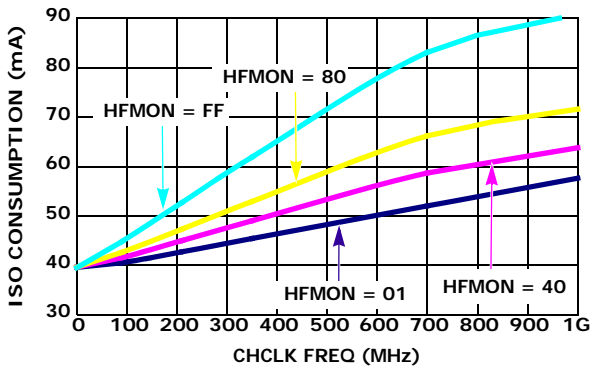


FIGURE 7. HFM OSCILLATOR CURRENT CONSUMPTION

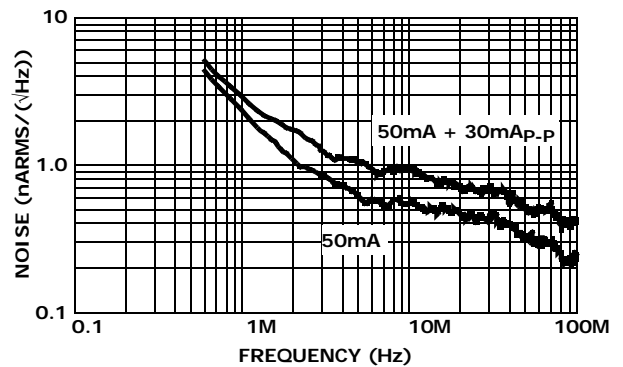


FIGURE 8. I_{OUTx} NOISE vs FREQUENCY

Typical Performance Curves (Continued)

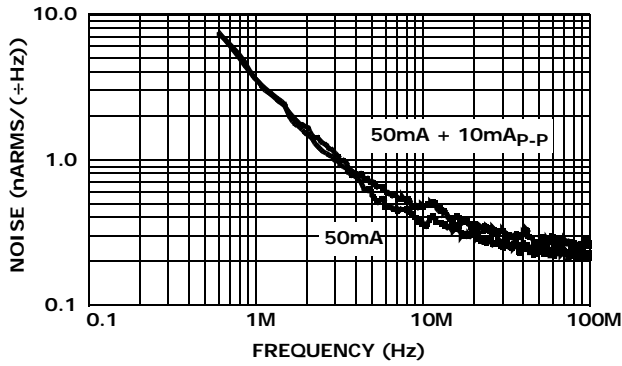


FIGURE 9. I_{BLUE} NOISE vs FREQUENCY

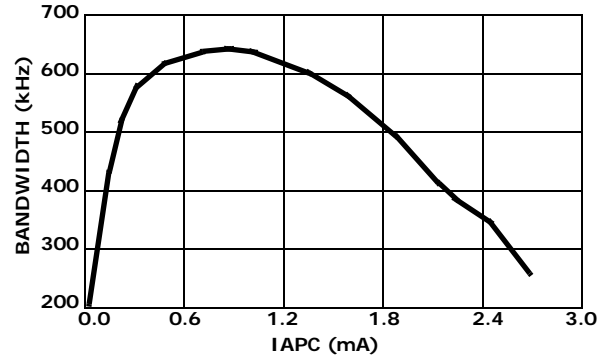


FIGURE 10. I_{OUT}/I_{APC} BANDWIDTH vs I_{APC}

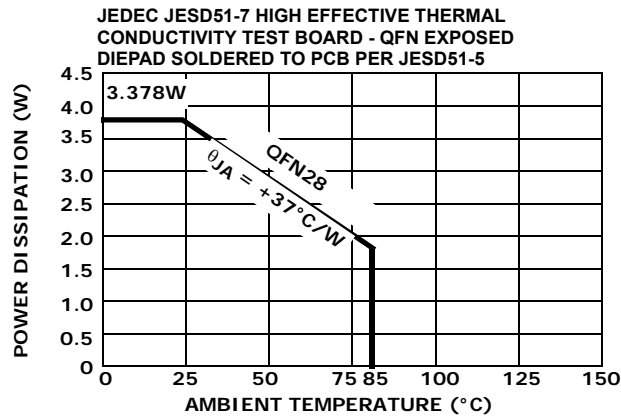


FIGURE 11. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

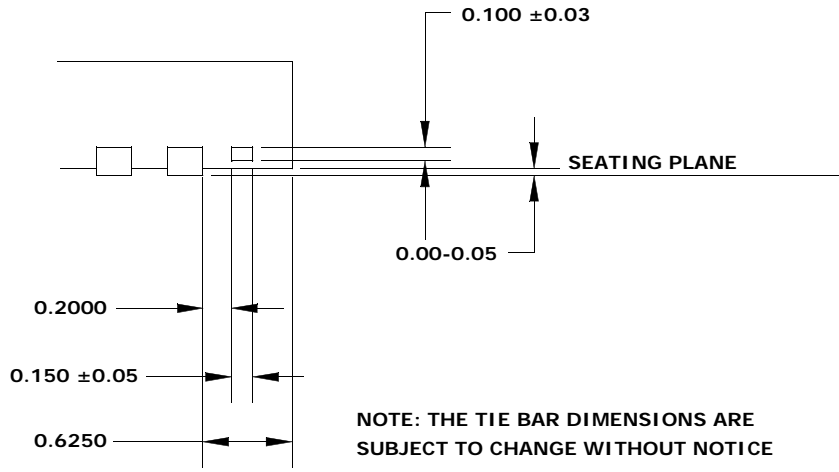


FIGURE 12. TIE BAR LOCATION FOR 4X5 QFN

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest Rev.

| DATE | REVISION | CHANGE |
|----------|----------|---|
| 12/3/15 | FN6909.3 | Removed ISL58781CRZ-EVAL from Ordering Information table. |
| 7/22/13 | FN6909.2 | Updated datasheet by changing Logo, removed side bar with part number, copyright on page 1 and changed Product Information verbiage to About Intersil verbiage on page 14. |
| 11/12/09 | FN6909.1 | Added Figure 12 "TIE BAR LOCATION FOR 4X5 QFN" on page 13 Added "Pin Number" column to "Pin Descriptions" on page 3 On page 7: In HFM spec Table, for IMAX-RED-OFF-LINK, IMAX-RED-OFF-UNLINK & IMAX-BLUE-OFF parameters, changed "HFMOFF = 0x7FF" test condition to "HFMOFF = 0xFFFF": since HFMOFF DAC is 12 bits now. On page 7: In HFM spec Table, Reg 1-21h=x7h for Imax_Blue_ON: Imax_Blue_On (Blue HFM ON amplitude) does not depend on Reg 1-21h setting. So, deleted "Reg 1-21h=x7h" condition |
| 9/2/09 | FN6909.0 | Initial release. |

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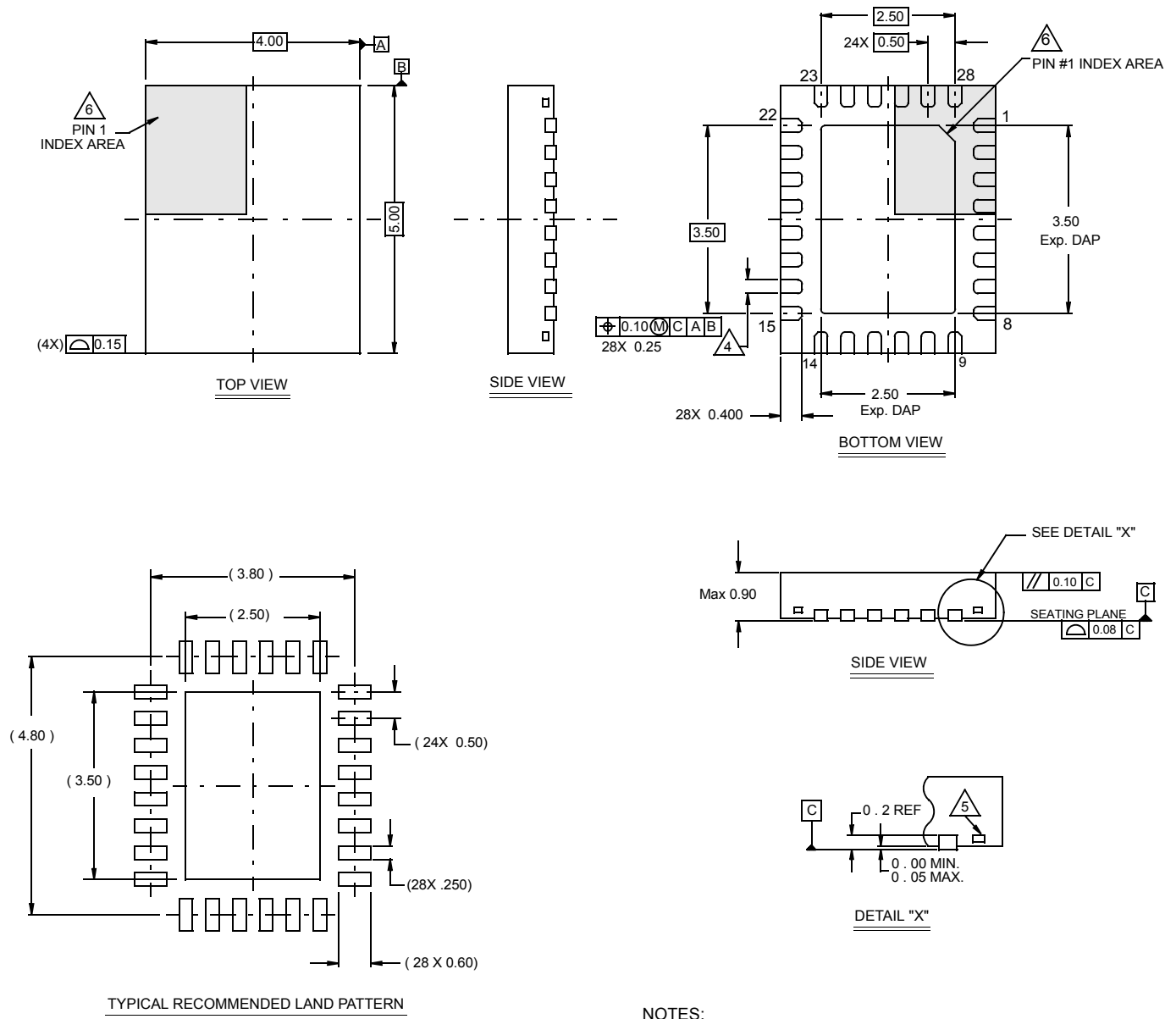
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Package Outline Drawing

L28.4x5A

28 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE

Rev 2, 06/08



NOTES:

1. Dimensions are in millimeters.
Dimensions in () for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal \pm 0.05
4. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.